## **Surface Mount Dual PNP Transistor**

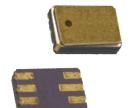
## 2N5796U

## Obsolete (2N5796UTX, 2N5796UTXV)

# **Electronics**

#### Features:

- Ceramic 6 pin surface mount package
- Small package to minimize circuit board area
- · Hermetically sealed
- Electrical performance similar to dual 2N2907A
- Processed per MIL-PRF-19500/496



#### **Description:**

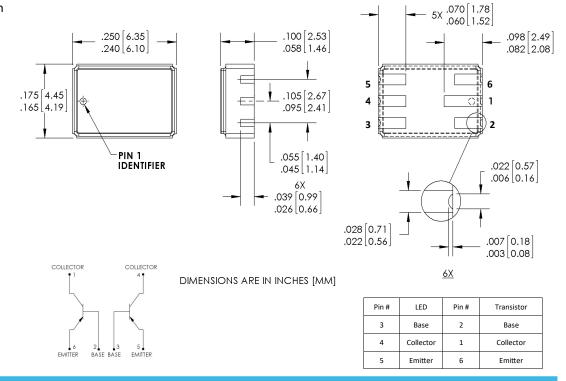
The 2N5796U (TX, TXV - Obsolete) are hermetically sealed, ceramic surface mount devices, consisting of two individual silicon PNP transistors. The six pin ceramic package is ideal for designs where board space and device weight are important design considerations.

Typical screening and lot acceptance tests are per MIL-PRF-19500/496. The burn-in condition is  $V_{CB} = 30 \text{ V}$ ,  $P_D = 300 \text{ mW}$  each transistor,  $T_A = 25^{\circ}$  C. Refer to MIL-PRF-19500/496 for complete requirements.

When ordering parts without processing, do not use the TX or TXV suffix.

#### **Applications:**

- General switching
- Amplification
- Signal processing
- Radio transmission
- Logic gates



# **Surface Mount Dual PNP Transistor**

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## **Electrical Specifications**

## **Absolute Maximum Ratings** (T<sub>A</sub> = 25° C unless otherwise noted)

Collector-Emitter Voltage	60 V
Collector-Base Voltage	60 V
Emitter-Base Voltage	5 V
Collector Current-Continuous	600 mA
Operating Junction Temperature (T <sub>J</sub> )	-65° C to + 200° C
Storage Junction Temperature (T <sub>stg</sub> )	-65° C to + 200° C
Power Dissipation @ T <sub>A</sub> = 25° C	0.5 W
Power Dissipation @ Tc = 25° C	0.6 W <sup>(1)</sup>
Soldering Temperature (vapor phase reflow for 30 seconds)	215° C
Soldering Temperature (heated collet for 5 seconds)	260° C

## **Electrical Characteristics** (T<sub>A</sub> = 25° C unless otherwise noted)

SYMBOL	PARAMETER	MIN	MAX	UNITS	TEST CONDITIONS			
OFF CHAR	OFF CHARACTERISTICS							
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	75	-	-	I <sub>C</sub> = 10 μA			
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage	60	-	V	I <sub>C</sub> = 10 mA <sup>(1)</sup>			
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	5	-	V	Ι <sub>Ε</sub> = 10 μΑ			
I <sub>CBO1</sub>	Collector-Base Cutoff Current	-	10	nA	V <sub>CB</sub> = 50 V			
I <sub>CBO2</sub>	Collector-Base Cutoff Current	-	10	μΑ	V <sub>BC</sub> = 50 V, T <sub>A</sub> = 150° C			
I <sub>EBO</sub>	Emitter-Base Cutoff Current	-	100	nA	V <sub>EB</sub> = 3 V			
h <sub>FE1</sub>		75	-	-	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 100 μA			
h <sub>FE2</sub>	Forward-Current Transfer Ratio	100	-	-	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 1.0 mA			
h <sub>FE3</sub>		100	-	-	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 10 mA <sup>(1)</sup>			
h <sub>FE4</sub>		100	300	-	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 150 mA <sup>(1)</sup>			
h <sub>FE5</sub>		50	-	-	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 300 mA <sup>(1)</sup>			
h <sub>FE6</sub>		50	-	-	V <sub>CE</sub> = 1.0 V, I <sub>C</sub> = 150 mA <sup>(1)</sup>			
h <sub>FE7</sub>		40	-	-	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 150 mA, T <sub>A</sub> = -55° C <sup>(1)</sup>			

#### Note:

1. Pulsed Test: Pulse Width = 300  $\mu s$   $\pm$  50, 1-2 % Duty Cycle

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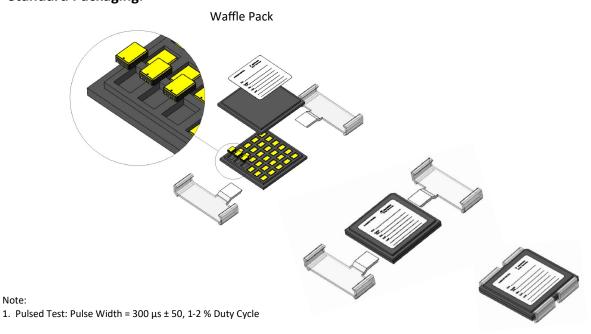


# **Electrical Specifications**

Electrical Characteristics (T<sub>A</sub> = 25° C unless otherwise noted)

SYMBOL	PARAMETER	MIN	MAX	UNITS	TEST CONDITIONS			
Off Charac	Off Characteristics continued							
V <sub>CE(SAT)1</sub>	Collector-Emitter Saturation Voltage	-	0.4	V	I <sub>C</sub> = 150 mA, I <sub>B</sub> = 15 mA <sup>(1)</sup>			
V <sub>CE(SAT)2</sub>	Collector-Emitter Saturation Voltage	-	1.6	٧	I <sub>C</sub> = 500 mA, I <sub>B</sub> = 50 mA <sup>(1)</sup>			
V <sub>BE(SAT)1</sub>	Base-Emitter Saturation Voltage	-	1.3	٧	I <sub>C</sub> = 150 mA, I <sub>B</sub> = 15 mA <sup>(1)</sup>			
V <sub>BE(SAT)1</sub>	Base-Emitter Saturation Voltage	-	2.6	٧	I <sub>C</sub> = 500 mA, I <sub>B</sub> = 50 mA <sup>(1)</sup>			
h <sub>fe</sub>	Magnitude of Small-Signal Short-Circuit Forward Current Transfer Ratio	2	10	-	V <sub>CE</sub> = 20 V, I <sub>C</sub> = 20 mA, f = 100 MHz			
C <sub>obo</sub>	Open Circuit Output Capacitance	-	8	pF	$V_{CB} = 10 \text{ V, } I_E = 0, 100 \text{ kHZ} \le f \le 1 \text{ MHz}$			
C <sub>ibo</sub>	Input Capacitance (output open)	-	25	pF	$V_{EB} = 2.0 \text{ V}, I_{E} = 0, 100 \text{ kHZ} \le f \le 1 \text{ MHz}$			
t <sub>on</sub>	Turn-on Time	-	50	ns	V <sub>CC</sub> = 30 V, I <sub>C</sub> = 150 mA, I <sub>B1</sub> = 15 mA, PW = 200 ns			
t <sub>off</sub>	Turn-off Time	-	140	ns	V <sub>CC</sub> = 30 V, I <sub>C</sub> = 150 mA, I <sub>B1</sub> = I <sub>B2</sub> = 15 mA, PW = 200 ns			

## **Standard Packaging:**



General Note

Note: